


PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

| | | |
|----------------------|---|--------------------------------------|
| 1.1 Company |  | STMicroelectronics International N.V |
| 1.2 PCN No. | RF OPTICAL COMM/26/16077 | |
| 1.3 Title of PCN | RWR55CCE – NEW ADDITIONAL EWS TEST SITE IN ASE (Taiwan) | |
| 1.4 Product Category | WR55 product line: ST60A3H1 & ST60A3H2 | |
| 1.5 Issue date | 2026-03-17 | |

2. PCN Team

| | |
|---------------------------|--------------------------|
| 2.1 Contact supplier | |
| 2.1.1 Name | ROBERTSON HEATHER |
| 2.1.2 Phone | +1 8475853058 |
| 2.1.3 Email | heather.robertson@st.com |
| 2.2 Change responsibility | |
| 2.2.1 Product Manager | Ghiath AL-KADI |
| 2.1.2 Marketing Manager | Joel BIELLE-BIARREY |
| 2.1.3 Quality Manager | Romain ZINI |

3. Change

| | | |
|--------------|---|----------------------------|
| 3.1 Category | 3.2 Type of change | 3.3 Manufacturing Location |
| Transfer | Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Electrical wafer sort (SOP 2617) | ST Grenoble; ASE Kaohsiung |

4. Description of change

| | | |
|--|---|-----------------------|
| | Old | New |
| 4.1 Description | EWS in ST Grenoble | EWS in ASE -Kaohsiung |
| 4.2 Anticipated Impact on form, fit, function, quality, reliability or processability? | No impact of the change expected on Form, Fit, functionality, Quality and Reliability of the product. | |

5. Reason / motivation for change

| | |
|----------------------|---|
| 5.1 Motivation | The additional EWS site at ASE Kaohsiung is introduced to: - Increase EWS capacity for the above products. - Improve manufacturing flexibility. ASE Kaohsiung is already qualified to perform EWS on several other ST products. In order to have better flexibility to increase the EWS capability for these products. ASE Kaohsiung is already qualified to run EWS on several ST products. |
| 5.2 Customer Benefit | CAPACITY INCREASE |

6. Marking of parts / traceability of change

| | |
|-----------------|---|
| 6.1 Description | The internal traceability will allow ST to retrieve the EWS die test location (Grenoble or ASE Kaohsiung) for any affected product. |
|-----------------|---|

7. Timing / schedule

| | |
|-------------------------------------|--------------|
| 7.1 Date of qualification results | 2026-04-03 |
| 7.2 Intended start of delivery | 2026-05-20 |
| 7.3 Qualification sample available? | Upon Request |

8. Qualification / Validation

| | | | |
|--|-------------|------------|--|
| 8.1 Description | | | |
| 8.2 Qualification report and qualification results | In progress | Issue Date | |

9. Attachments (additional documentations)

16077 Public product.pdf
16077 WR55 ST60A AiP - EWS in ASE.pdf

10. Affected parts

| 10. 1 Current | | 10.2 New (if applicable) |
|-------------------------|-------------------------|--------------------------|
| 10.1.1 Customer Part No | 10.1.2 Supplier Part No | 10.1.2 Supplier Part No |
| | ST60A3H1C1CCEPY3 | |

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Public Products List

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PCN Title : RWR55CCE – NEW ADDITIONAL EWS TEST SITE IN ASE (Taiwan)

PCN Reference : RF OPTICAL COMM/26/16077

Subject : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

| | | |
|------------------|------------------|--|
| ST60A3H1C1CCEPY3 | ST60A3H1C1CCEPT3 | |
|------------------|------------------|--|

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